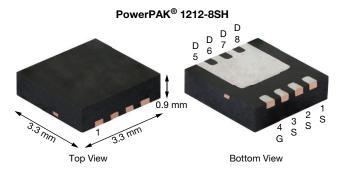
SiSH108DN

www.vishay.com

Vishay Siliconix

COMPLIANT

N-Channel 20 V (D-S) Fast Switching MOSFET



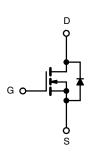
PRODUCT SUMMARY	
V _{DS} (V)	20
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.0049
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.0061
Q _g typ. (nC)	20
I _D (A)	22
Configuration	Single

FEATURES

- TrenchFET[®] Gen II power MOSFET for ultra low on-resistance
 RoHS
- 100 % R_a tested
- Material categorization: for definitions of **FREE** compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Synchronous rectification
- Point-of-load converters
- Protection devices
- Hot swap



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK 1212-8
Lead (Pb)-free and halogen-free	SiSH108DN-T1-GE3

ABSOLUTE MAXIMUM RATINGS	(T _A = 25 °C, un	less otherwise	noted)		
PARAMETER		SYMBOL	10 s	STEADY STATE	UNIT
Drain-source voltage		V _{DS}	20	20	V
Gate-source voltage		V _{GS}	± 16	± 16	
Continuous drain current (T _J = 150 °C) ^a	T _A = 25 °C	1	22	14	
	T _A = 70 °C	I _D	17.6	11.2	
Pulsed drain current		I _{DM}	60	60	A
Continuous source current (diode conduction) ^a		I _S	3.2	1.3	
Single avalanche current	L = 0.1 mH	I _{AS}	22	22	
Single avalanche energy		E _{AS}	24	24	mJ
Maximum power dissipation ^a	T _A = 25 °C	PD	3.8	1.5	W
	T _A = 70 °C		2.0	0.8	vv
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150		0°
Soldering recommendations (peak temperature) b, c			2	60	-0

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction to ambient a	t ≤ 10 s	Р	24	33	
Maximum junction-to-ambient ^a	Steady state	R _{thJA}	65	81	°C/W
Maximum junction-to-case (drain)	Steady state	R _{thJC}	1.9	2.4	

Notes

a. Surface mounted on 1" x 1" FR4 board

b. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK 1212-8SH is a leadless package within the PowerPAK 1212-8 package family. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

c. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

S18-0685-Rev. A, 09-Jul-2018

1 For technical questions, contact: <u>pmostechsupport@vishay.com</u>

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SiSH108DN

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1	-	2	V	
Gate body leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 16 V	-	-	± 100	nA	
Zero gate voltage drain current		$V_{DS} = 20 V, V_{GS} = 0 V$	-	-	1		
	IDSS	V_{DS} = 20 V, V_{GS} = 0 V, T_J = 55 °C	-	-	5	μΑ	
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	40	-	-	А	
Drain aquiras an atata rasistanas à	Р	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 22 \text{ A}$	D = 22 A - 0.0041 (0.0049		
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 19.7 A - 0.0050			0.0061	Ω	
Forward transconductance a	g _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 22 \text{ A}$	-	88	-	S	
Diode forward voltage ^a	V _{SD}	$I_{S} = 3.2 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.75	1.2	V	
Dynamic ^b							
Total gate charge	Qg		-	20	30		
Gate-source charge	Q _{gs}	V_{DS} = 10 V, V_{GS} = 4.5 V, I_{D} = 22 A	-	6.3	-	nC	
Gate-drain charge	Q _{gd}		-	4.9	-		
Gate resistance	Rg	f = 1 MHz	0.7	1.4	2.1	Ω	
Turn-on delay time	t _{d(on)}		-	10	15		
Rise time	t _r	V_{DD} = 20 V, R_L = 20 Ω	-	10	15		
Turn-off delay time	t _{d(off)}	$I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$	-	60	130	ns	
Fall time	t _f		-	10	15		
Source-drain reverse recovery time	t _{rr}		-	30	60		
Reverse recovery charge	Q _{rr}	I _F = 3.2 A, di/dt = 100 A/μs	-	20	36	nC	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

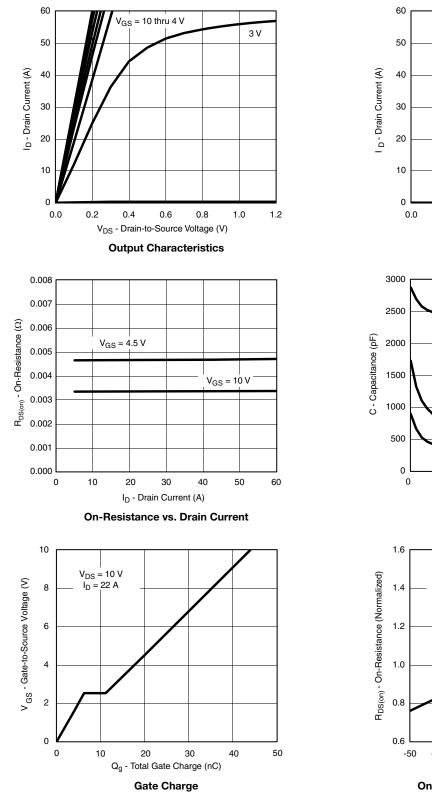
b. Guaranteed by design, not subject to production testing

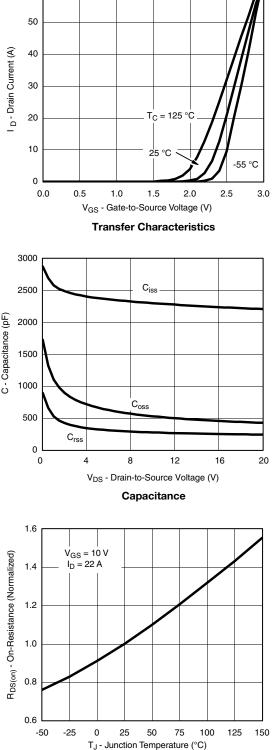
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



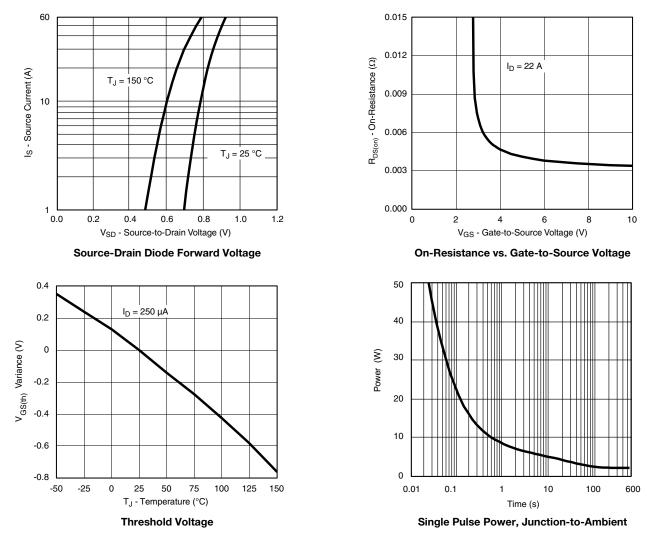


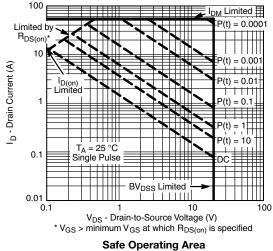
On-Resistance vs. Junction Temperature

Document Number: 79330



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

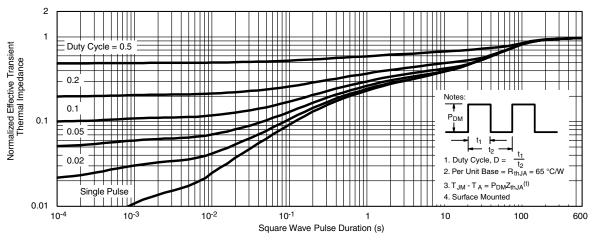




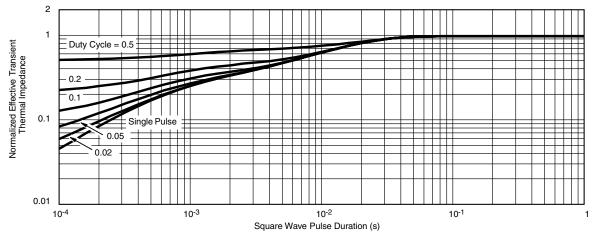
4



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

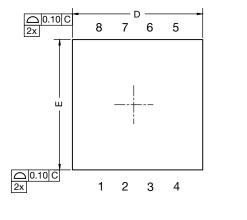


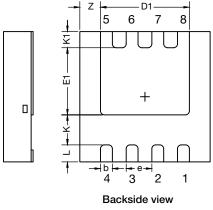
Normalized Thermal Transient Impedance, Junction-to-Case

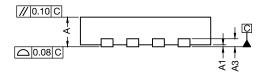
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PowerPAK[®] 1212-SWLH







DIM.	MILLIMETERS			INCHES				
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	0.82	0.90	0.98	0.032	0.035	0.038		
A1	0	-	0.05	0	-	0.002		
A3	0.20 ref.			0.008 ref.				
b		0.30 BSC			0.012 BSC			
D	3.30 BSC			0.130 BSC				
D1	2.15	2.25	2.35	0.084	0.088	0.092		
E		3.30 BSC			0.130 BSC			
E1	1.60	1.70	1.80	0.063	0.067	0.071		
е	0.65 BSC				0.026 BSC			
К		0.76 typ.			0.030 typ.			
K1	0.41 typ.			0.016 typ.				
L	0.43 BSC		0.017 BSC					
Z		0.525 typ.		0.021 typ.				



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